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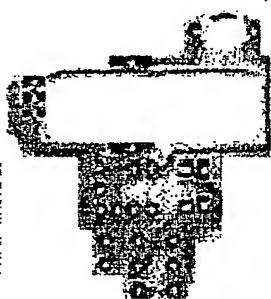
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(54) Title: HEARING AID USING PRINTED CIRCUIT BOARD



(57) Abstract: A hearing aid using a printed circuit board (PCB) is provided which minimizes internal wires since components of the hearing aid are disposed on the PCB. Since individual soldering of amplifier terminals and components of the hearing aid in an existing hearing aid faceplate manufacturing process which consumes the longest time can be automatically performed on the PCB in which the hearing aid components are automatically soldered and disposed, a total process time can be remarkably shortened.

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